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# 74AUP1G95 TinyLogic<sup>®</sup> Low Power Universal Configurable Two-Input Logic Gate (Open Drain Output)

## Features

- 0.8 V to 3.6 V V<sub>CC</sub> Supply Operation
- 3.6 V Over-Voltage Tolerant I/Os at V<sub>CC</sub> from 0.8V to 3.6 V
- Extremely High Speed tPD - 3.2 ns: Typical at 3.3 V
- Power-Off High-Impedance Inputs and Outputs
- Low Static Power Consumption
  I<sub>CC</sub>=0.9 μA Maximum
- Low Dynamic Power Consumption
  C<sub>PD</sub>=3.0 pF Typical at 3.3 V
- Ultra-Small MicroPak<sup>™</sup> Packages

## Description

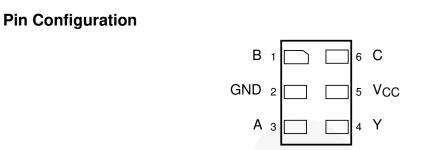
The 74AUP1G95 is a universal, configurable, two-input logic gate with an open-drain output that provides a high-performance and low-power solution for battery-powered portable applications. This product is designed for a wide low voltage operating range (0.8 V to 3.6 V) and guarantees very low static and dynamic power consumption across the entire voltage range. All inputs are implemented with hysteresis to allow for slower transition input signals and better switching noise immunity.

The 74AUP1G95 provides for multiple functions, as determined by various configurations of the three inputs. The potential logic functions provided are MUX, AND, OR, NAND, NOR, inverter, and buffer (*see Figure 2 through Figure 8*).

### **Ordering Information**

Part Number	Top Mark	Package	Packing Method
74AUP1G95L6X	AN	6-Lead, MicroPak™, 1.0 mm Wide	5000 Units on Tape & Reel
74AUP1G95FHX	AN	6-Lead, MicroPak2™, 1x1 mm Body, .35 mm Pitch	5000 Units on Tape & Reel

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## **Pin Definitions**

Pin #	Name	Description
1	В	Data Input
2	GND	Ground
3	A	Data Input
4	Y	Output (Open Drain)
5	V <sub>cc</sub>	Supply Voltage
6	С	Data Input

# **Function Table**

	Inputs		Y=Output
С	В	Α	
L	L	L	L
L	L	Н	L
L	Н	L	H <sup>(1</sup>
L	н	н	H <sup>(1)</sup>
Н	L	L	L
н	L	Н	H <sup>(1)</sup>
н	н	L	L
Н	Н	Н	H <sup>(1)</sup>

H = HIGH Logic Level

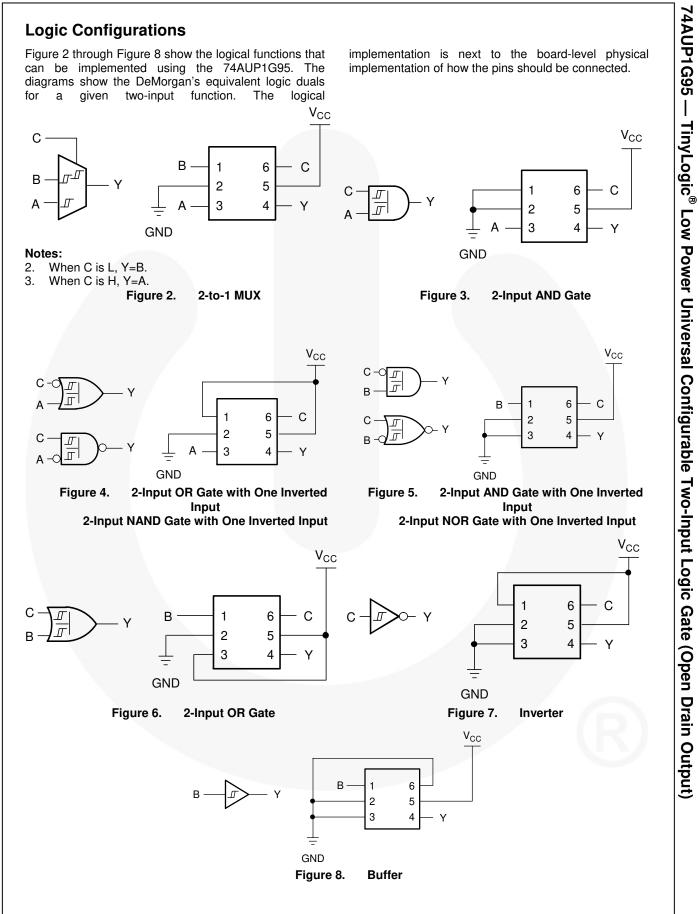
L = LOW Logic Level

Note:

1. High impedance output state, open drain.

## **Function Selection Table**

2-Input Logic Function	Connection Configuration
2-to-1 MUX	Figure 2
2-Input AND Gate	Figure 3
2-Input OR Gate with One Inverted Input	Figure 4
2-Input NAND Gate with One Inverted Input	Figure 4
2-Input AND Gate with One Inverted Input	Figure 5
2-Input NOR Gate with One Inverted Input	Figure 5
2-Input OR Gate	Figure 6
Inverted	Figure 7
Buffer	Figure 8



# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Para	ameter	Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	4.6	V
V <sub>IN</sub>	DC Input Voltage		-0.5	4.6	V
V <sub>OUT</sub> <sup>(2)</sup>	DC Output Voltage		-0.5	4.6	V
I <sub>IK</sub>	DC Input Diode Current	V <sub>IN</sub> < 0 V		-50	mA
Ι <sub>ΟΚ</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V		-50	mA
I <sub>OL</sub>	DC Output Sink Current		+50	mA	
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current per	Supply Pin		±50	mA
T <sub>STG</sub>	Storage Temperature Range		-65	+150	°C
TJ	Junction Temperature Under B	ias		+150	°C
TL	Junction Lead Temperature, Sc	oldering 10s		+260	°C
P <sub>D</sub>	P <sub>D</sub> Power Dissipation at +85°C	MicroPak™-6		130	mW
		MicroPak2 <sup>™</sup> -6		120	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	v
ESD	Charged Device Model, JEDEC	:JESD22-C101		2000	V

#### Note:

2.  $I_{O}$  absolute maximum rating must be observed.

# **Recommended Operating Conditions**<sup>(3)</sup>

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Condition	Min.	Max.	Unit	
V <sub>CC</sub>	Supply Voltage		0.8	3.6	V	
V <sub>IN</sub>	Input Voltage		0	3.6	V	
V <sub>OUT</sub>	Output Voltage		0	3.6	V	
		V <sub>CC</sub> =3.0 V to 3.6 V		±4.0		
		V <sub>CC</sub> =2.3 V to 2.7 V		±3.1	mA	
		V <sub>CC</sub> =1.65 V to 1.95 V		±1.9		
I <sub>OL</sub>	Output Current	V <sub>CC</sub> =1.4 V to 1.6 V		±1.7		
		V <sub>CC</sub> =1.1 V to 1.3 V		±1.1		
		V <sub>CC</sub> =0.8 V		±20.0	μA	
T <sub>A</sub>	Operating Temperature, Free Air		-40	+85	°C	
0	Thermal Resistance	MicroPak™-6		500	°C/W	
$\theta_{JA}$		MicroPak2 <sup>™</sup> -6		560		

#### Note:

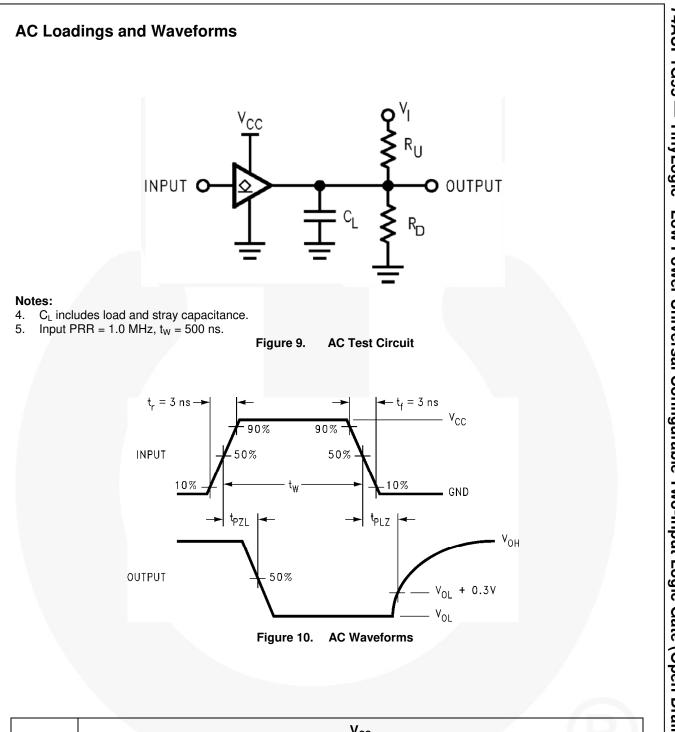
3. Unused inputs must be held HIGH or LOW. They may not float.

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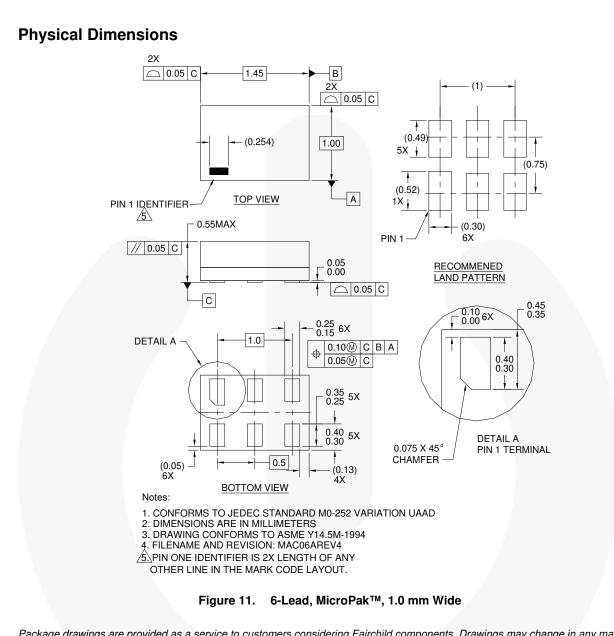
• • •				T <sub>A</sub> =	25°C	T <sub>A</sub> =-40	to 85°C	
Symbol	Parameter	V <sub>cc</sub>	Condition	Min.	Max.	Min.	Max.	Unit
		0.80		0.30	0.60	0.30	0.60	
		1.10		0.53	0.90	0.53	0.90	
V	Positive	1.40		0.74	1.11	0.74	1.11	v
V <sub>P</sub>	Threshold Voltage	1.65		0.91	1.29	0.91	1.29	v
		2.30		1.37	1.77	1.37	1.77	
		3.00		1.88	2.29	1.88	2.29	
		0.80		0.10	0.60	0.10	0.60	
		1.10		0.26	0.65	0.26	0.65	
V	Negative Threshold Voltage	1.40		0.39	0.75	0.39	0.75	v
$V_N$		1.65		0.47	0.84	0.47	0.84	v
		2.30		0.69	1.04	0.69	1.04	
		3.00		0.88	1.24	0.88	1.24	
		0.80		0.07	0.50	0.07	0.50	
		1.10		0.08	0.46	0.08	0.46	
N	Hysteresis	1.40		0.18	0.56	0.18	0.56	- V
V <sub>H</sub>	Voltage	1.65		0.27	0.66	0.27	0.66	
		2.30		0.53	0.92	0.53	0.92	
		3.00		0.79	1.31	0.79	1.31	
		$0.80 \leq V_{CC} \leq 3.60$	I <sub>OL</sub> =20 μA		0.10		0.10	
		$1.10 \le V_{CC} \le 1.30$	I <sub>OL</sub> =1.1 mA		0.30 x V <sub>CC</sub>		0.30 x V <sub>CC</sub>	
	LOW Level	$1.40 \le V_{CC} \le 1.60$	I <sub>OL</sub> =1.7 mA		0.31 0	0.37		
V <sub>OL</sub>	Output	$1.65 \le V_{CC} \le 1.95$	I <sub>OL</sub> =1.9 mA		0.31		0.35	v
	Voltage	$2.30 \le V_{CC} \le 2.70$	I <sub>OL</sub> =3.1 mA		0.44		0.45	
		$2.70 \leq V_{CC} \leq 3.60$	I <sub>OL</sub> =4.0 mA		0.44		0.45	
I <sub>IN</sub>	Input Leakage Current	0V to 3.6V	$0 \leq V_{\text{IN}} \leq 3.6 \text{ V}$		±0.1		±0.5	μA
I <sub>OFF</sub>	Power Off Leakage Current	٥V	$\begin{array}{l} 0 \leq (V_{IN},V_O) \\ \leq 3.6 \ V \end{array}$		0.2		0.6	μA
$\Delta I_{OFF}$	Additional Power Off Leakage Current	0V to 0.2V	$V_{IN}$ or $V_{O}=0$ V to 3.6 V		0.2		0.6	μΑ
	Quiescent		$V_{\text{IN}}$ - $V_{\text{CC}}$ or GND		0.5		0.9	
I <sub>CC</sub>	Supply Current	0.8V to 3.6V	$V_{CC} \le V_{IN} \le 3.6 \ V$				±0.9	μA
$\Delta I_{CC}$	Increase in I <sub>CC</sub> per Input	3.3V	V <sub>IN</sub> =V <sub>CC</sub> -0.6 V		40.0		50.0	μA

O		N N	<b>o</b> ""		T <sub>A</sub> =25°C			to 85°C	
Symbol Parameter	V <sub>cc</sub>	Condition	Min.	Тур.	Max.	Min.	Мах	Unit	
		0.80			30				
	Propagation Delay	$1.10 \leq V_{CC} \leq 1.30$	C 15 pE	1.0	10.1	18.9	1.0	19.9	
		$1.40 \leq V_{CC} \leq 1.60$	C <sub>L</sub> =15 pF, R <sub>U</sub> =R <sub>D</sub> =5 KΩ	1.0	6.6	11.4	1.0	12.2	
ι <sub>PZL</sub> , ι <sub>PLZ</sub>		$1.65 \leq V_{CC} \leq 1.95$	$V_1 = 2 \times (V_{CC})$ (see Figure 9)	1.0	6.3	8.7	1.0	9.7	
		$2.30 \leq V_{CC} \leq 2.70$		1.0	4.7	6.9	1.0	7.5	
		$3.00 \leq V_{CC} \leq 3.60$		1.0	4.6	6.8	1.0	7.4	
C <sub>IN</sub>	Input Capacitance	0			0.8				pF
C <sub>OUT</sub>	Output Capacitance	0			1.7				pF
		0.80			3.0				
		$1.10 \leq V_{CC} \leq 1.30$			3.1				рF
<u> </u>	Power	$1.40 \leq V_{CC} \leq 1.60$	V <sub>IN</sub> =0 V or V <sub>CC</sub> ,		3.2				
	Dissipation Capacitance	$1.65 \leq V_{CC} \leq 1.95$	f=10 MHz		3.4				
		$2.30 \leq V_{CC} \leq 2.70$			3.8				
		$3.00 \le V_{CC} \le 3.60$			4.4				

AC Electrical Characteristics



Symbol			Vo	c		
Symbol	3.3 V ± 0.3 V	2.5 V ± 0.2 V	1.8 V ± 0.15 V	1.5 V ± 0.10 V	1.2 V ± 0.10 V	0.8 V
V <sub>mi</sub>	V <sub>CC</sub> /2	V <sub>cc</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2
V <sub>mo</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.1 V	V <sub>OL</sub> + 0.1 V	V <sub>OL</sub> + 0.1 V



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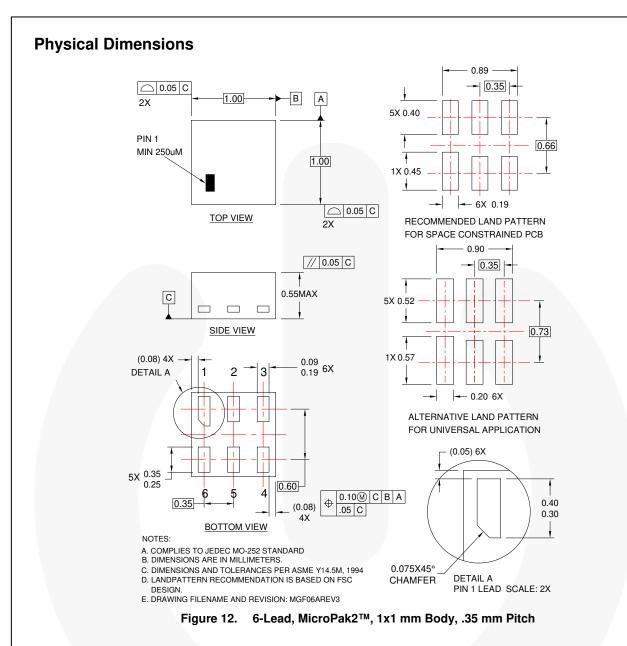
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### **Tape and Reel Specifications**

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
L6X	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
	Leader (Start End)	125 (Typical)	Empty	Sealed
FHX	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

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Datasheet Identification	Product Status	Definition
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. 162

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